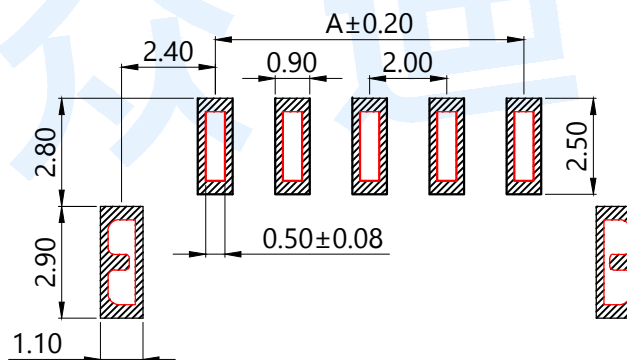
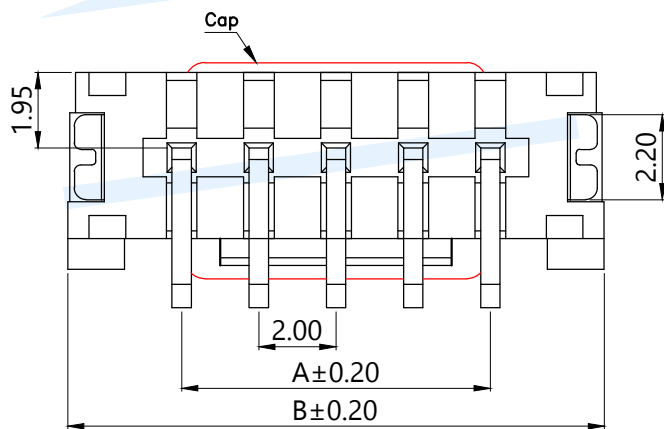
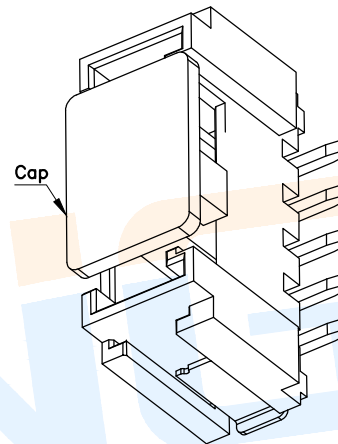
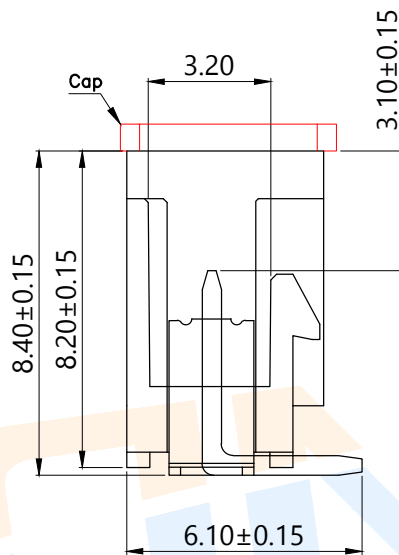
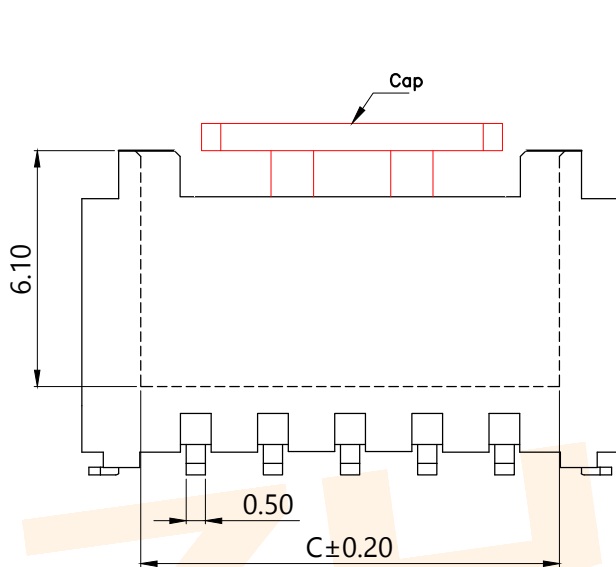


RoHS



适用线路板 (PCB LAYOUT)

Model No.	Pin	A	B	C
WAFER-HY2.0-2PLT-W1	2	2.00	7.90	4.80
WAFER-HY2.0-3PLT-W1	3	4.00	9.90	6.80
WAFER-HY2.0-4PLT-W1	4	6.00	11.90	8.80
WAFER-HY2.0-5PLT-W1	5	8.00	13.90	10.80
WAFER-HY2.0-6PLT-W1	6	10.00	15.90	12.80
WAFER-HY2.0-7PLT-W1	7	12.00	17.90	14.80
WAFER-HY2.0-8PLT-W1	8	14.00	19.90	16.80
WAFER-HY2.0-9PLT-W1	9	16.00	21.90	18.80
WAFER-HY2.0-10PLT-W1	10	18.00	23.90	20.80
WAFER-HY2.0-11PLT-W1	11	20.00	25.90	22.80
WAFER-HY2.0-12PLT-W1	12	22.00	27.90	24.80
WAFER-HY2.0-13PLT-W1	13	24.00	29.90	26.80
WAFER-HY2.0-14PLT-W1	14	26.00	31.90	28.80
WAFER-HY2.0-15PLT-W1	15	28.00	33.90	30.80
WAFER-HY2.0-16PLT-W1	16	30.00	35.90	32.80
WAFER-HY2.0-17PLT-W1	17	32.00	37.90	34.80
WAFER-HY2.0-18PLT-W1	18	34.00	39.90	36.80
WAFER-HY2.0-19PLT-W1	19	36.00	41.90	38.80
WAFER-HY2.0-20PLT-W1	20	38.00	43.90	40.80
WAFER-HY2.0-□□PLT-W1 (-P=盘装, 非盘装不启用)				

Specifications/技术规格:

- 1.Poles/线数: 2~20P
- 2.Wire range/适用线规: AGW 30#~24#
- 3.Applicable PC board thickness/适用PC板厚度: 0.8~1.6mm
- 4.Current rating/额定电流: 2.0A
- 5.Voltage rating/额定电压: 250V DC/AC
- 6.Insulation Resistance/绝缘电阻: 1000MΩ Min
- 7.Dielectric Withstanding/ 耐电压: 1000V AC/minute
- 8.Contact Resistance/ 接触电阻: 20mΩ Max
- 9.Operating Temperature/ 工作温度: -25℃ to +85℃

Ⓒ	Soldering lug		1	Brass	Plating Sn
Ⓑ	Terminal			Brass	Plating Sn
Ⓐ	Housing		1	LCP	Off White
NO.	Name	Number	Qty	Materil	Remarks
ZHONGDI® Zhongdi Electronic Technology Co., Ltd					
					
design		date		name	WAFER CONNECTOR
Review		date			
Approved		date		model	WAFER-HY2.0-□□PLT-W1
number:					
on 1:1	unit	mm	gape number		A4
					